

UNITED STATES OF AMERICA
COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

OFGS FILE NO.
P/4076-8

I, As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHODS AND APPARATUS FOR CLEANING AN IC ENCAPSULATION SYSTEM

the specification of which is attached hereto, unless the following box is checked:

☐ was filed on _____ as United States patent Application Number or PCT International patent application number _____ and was amended on _____ (if any).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information known to be material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code §119 of any foreign application(s) for patent or inventor's certificate or United States provisional application(s) listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign or Provisional Application(s)

| COUNTRY | APPLICATION NUMBER | DATE OF FILING (day, month, year) | PRIORITY CLAIMED UNDER 35 U.S.C. 119 |
|---------|--------------------|--------------------------------------|---|
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

| UNITED STATES APPLICATION NUMBER | DATE OF FILING (day, month, year) | STATUS (patented, pending, abandoned) |
|-------------------------------------|--------------------------------------|--|
| | | |
| | | |
| | | |

I hereby appoint customer no. 2352 OSTROLENK, FABER, GERB & SOFFEN, LLP, and the members of the firm, Samuel H. Weiner - Reg. No. 18,510; Jerome M. Berliner - Reg. No. 18,653; Robert C. Faber - Reg. No. 24,322; Edward A. Meilman - Reg. No. 24,735; Steven I. Weisburd - Reg. No. 27,409; Max Moskowitz - Reg. No. 30,576; Stephen A. Soffen - Reg. No. 31,063; James A. Finder - Reg. No. 30,173; William O. Gray, III - Reg. No. 30,944; Louis C. Dujmich - Reg. No. 30,625; Douglas A. Miro - Reg. No. 31,643, and Michael J. Scheer - Reg. No. 34,425, as attorneys with full power of substitution and revocation to prosecute this application, to transact all business in the Patent & Trademark Office connected therewith and to receive all correspondence.

SEND CORRESPONDENCE TO: **OSTROLENK, FABER, GERB & SOFFEN, LLP** DIRECT TELEPHONE CALLS TO:
1180 AVENUE OF THE AMERICAS
NEW YORK, NEW YORK 10036-8403 (212) 382-0700
CUSTOMER NO. 2352

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| | | | |
|---|--|------------------------------------|------|
| FULL NAME OF SOLE OR FIRST INVENTOR See Yap ONG | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) Singapore 806746 | | COUNTRY OF CITIZENSHIP Malaysia | |
| POST OFFICE ADDRESS Blk 53 Sunrise Avenue, #03-23, Singapore 806746 | | | |
| FULL NAME OF SECOND JOINT INVENTOR (IF ANY) Kock Kien WEE | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) Singapore 670680 | | COUNTRY OF CITIZENSHIP Malaysia | |
| POST OFFICE ADDRESS Blk 670, Choa Chu Kang Crescent, #14-509, Singapore 670680 | | | |

☒ CONTINUED ON PAGE 2

| UNITED STATES OF AMERICA COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION | | OFGS FILE NO. P/4076-8 | |
|--|--------------------|--|---|
| COUNTRY | APPLICATION NUMBER | DATE OF FILING (day, month, year) | PRIORITY CLAIMED UNDER 35 U.S.C. 119 |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| | | | YES ___ NO ___ |
| <p>I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.</p> | | | |
| FULL NAME OF THIRD JOINT INVENTOR, IF ANY Shu Chuen HO | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) Singapore 298189 | | COUNTRY OF CITIZENSHIP Singapore | |
| POST OFFICE ADDRESS Blk 806, Thomson Road, #05-11, Singapore 298189 | | | |
| FULL NAME OF FOURTH JOINT INVENTOR, IF ANY Teng Hock KUAH | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) Singapore 760321 | | COUNTRY OF CITIZENSHIP Singapore | |
| POST OFFICE ADDRESS Blk 321, Yishun Central, #08-315, Singapore 760321 | | | |
| FULL NAME OF FIFTH JOINT INVENTOR, IF ANY Jian WU | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) Singapore 760786 | | COUNTRY OF CITIZENSHIP People's Republic of China | |
| POST OFFICE ADDRESS Blk 786, Yishun Ring Road, #07-3502, Singapore 760786 | | | |
| FULL NAME OF SIXTH JOINT INVENTOR, IF ANY | | INVENTOR'S SIGNATURE | DATE |
| RESIDENCE (City and either State or Foreign Country) | | COUNTRY OF CITIZENSHIP | |
| POST OFFICE ADDRESS | | | |